



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
PATENT APPLICATION

In re Application of  
Eng et al.

Serial No: 09/766,477

Filed: 01/19/01

For: VERTICAL BALL GRID ARRAY INTEGRATED CIRCUIT PACKAGE

Docket: TI-22944.2

Art Unit: TBD

Examiner: TBD

0420  
2/9/01  
0300

#31B  
RE-MOT  
J. Rainier  
8/4/02

SECOND PRELIMINARY AMENDMENT

Assistant Commissioner for  
Patents  
Washington, D. C. 20231

Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(a)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on

3-6-01

Jackie McBride

OK to enter  
WJD  
9/26/01

Prior to examination in this case, please disregard the request to cancel claims 22-  
27 and instead cancel claims 11-20.

REMARKS

The above amendment is to correct an error. Claims 11-20 were elected in application serial no. 09/478,917. Favorable action and allowance of the application are respectfully requested.

Respectfully submitted,

Wade James Brady III  
Reg. No. 32,080

Texas Instruments Incorporated  
P. O. Box 655474, MS 3999  
Dallas, Texas 75265  
(972) 917-4371